imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

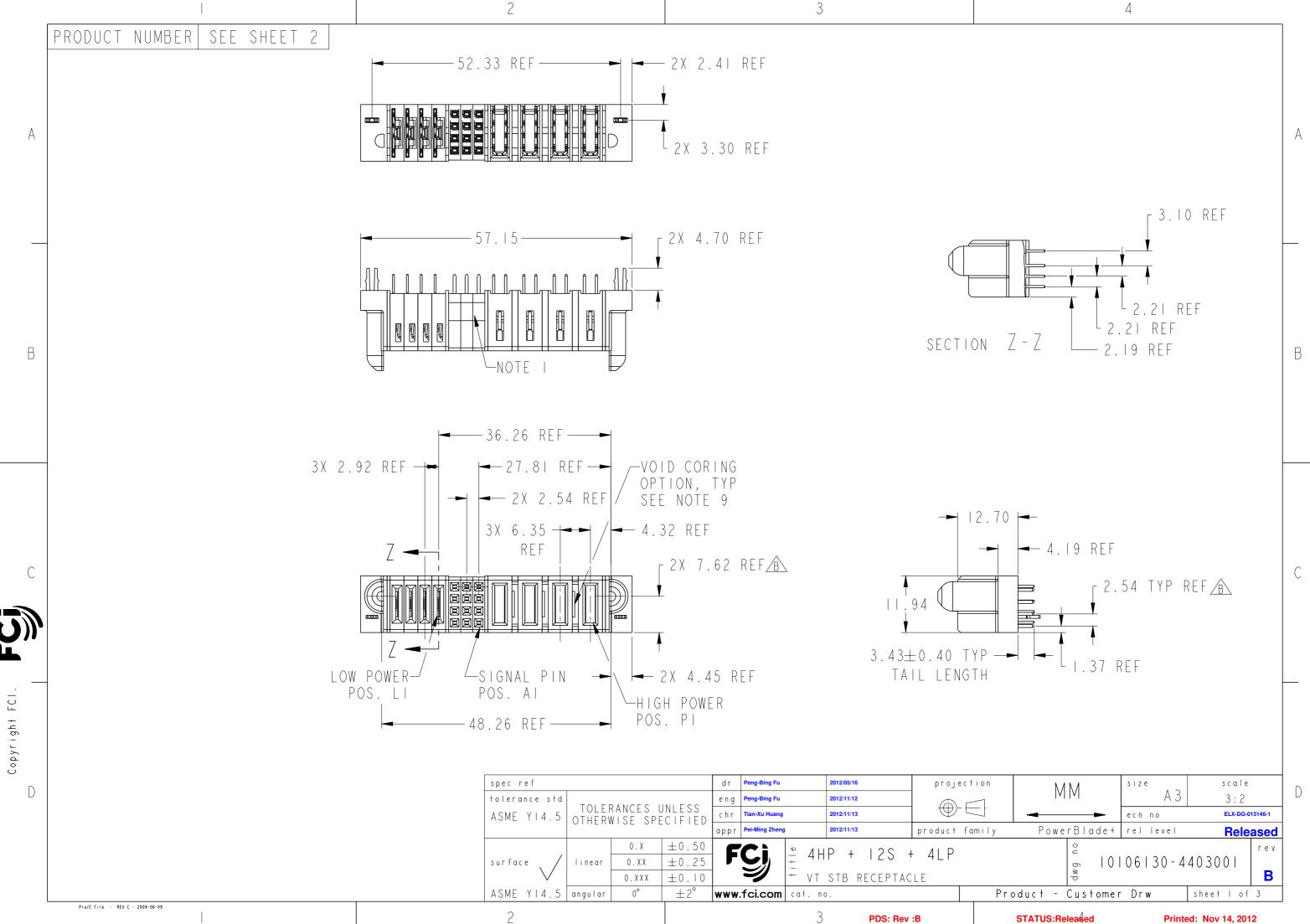
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





STATUS:Released

Printed: Nov 14, 2012

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PRODUCT NO.	ROW S		LP		S	HIGH POWER					
PRUDULI NU.		E1	L4 L3 L2 I	L1 3	2 1	P4	P3	P2	P1	E2	
0 06 30-440300 LF	D C B A		LRLRLRI			H3	H3	H6	H6		

2X Ø2.49±0.05 52.32 ⊕ Ø0.10M V U 39.04 3X 2.92 NOTE 6 29.85 3.10 NOTE 4-5.08 2.21 1.93 3X 6.35 2.21 ΤΥΡ 1.12 0 0 Ö Ö— 15.49 00000 0 0 0 0 0 0 0 0 MIN. 0 0 0 0 0 0 0 0 0000 00 0 0 0000 0 0 0 0 00 Ţ 2.54 2X 5.21 2.54 TYP ΤΥΡ V Ø1.02±0.07 TYP 2X 2.54 U $\oplus 0.100$ U -57.91 MIN. NOTE 6, 7 BSC NOTE 5

dr	Peng-Bing Fu Peng-Bing Fu Tian-Xu Huang		2012/05/16			proje	ect	ion
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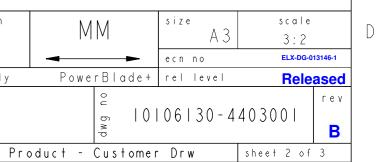
Pro/E File - REV C - 2009-06-09

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(CODE	DESCRIPTION	
	E	STD SIGNAL CONTACT	
	Н3	STD HIGH POWER CONTACT (3.43)	
	Η6	MFBL HIGH POWER CONTACT (3.43)	
	НА	METAL HOLD DOWN	A
	LR	STD LOW POWER CONTACT (3.43)	

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ſ	BSC	
	NOTE	5



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2 3 NOTES: I) "FCI", PART NUMBER AND DATE CODE TO BE MARKED ON THIS SURFACE. THE P/N CAN BE OMITTED IF THERE IS NOT ENOUGH SPACE ON THIS SURFACE. 2) MATERIALS: -HOUSING - GLASS FILLED WITH HIGH TEMP THERMOPLASTIC, UL94V-0. -SIGNAL CONTACT - COPPER ALLOY. -POWER CONTACT - HIGH CONDUCTIVITY COPPER ALLOY. 3) PLATING SPECIFICATION REFER TO FCI 10116351 4) DENOTES CONNECTOR KEEP OUT ZONE. 5) DATUM AND BASIC DIMENIONS WERE ESTABLISHED BY CUSTOMER. 6) ALL HOLE DIAMETERS ARE FINISHED HOLE SIZES. 7) I.15 \pm 0.025MM DRILLED HOLE PLATED WITH 0.00762MM MIN Sn OVER 0.0254-0.0762MM Cu PLATING TO ACHIEVE A 1.02 \pm 0.07MM HOLE. 8) PRODUCT SPECIFICATION REFER TO FCI GS-12-658. APPLICATION SPECIFICATION REFER TO FCI GS-20-141. PRODUCT PACKAGED IN TRAYS, REFER TO FCI GS-14-1502. 9) THE VOID CORING IN BETWEEN POWER MODULES, SIGNAL MODULES AND END MODULES ARE OPTIONAL AND THE SHAPE MAY BE DIFFERENT FOR OPTIMIZE THE MOLDING PROCESS. VOID CORING WILL NOT EFFECT TO PRODUCT FUNCTION. IO)A 🖻 SYMBOL WILL BE NEXT TO ANY DIMENSION, VIEW, OR BEEN MODIFIED WITH THE CURRENT DRAWING REVISION.

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